µOPALE V2-SL

Space Saver 1U rack mount Server



■ Ready for OEM with Modified COTS services

As processing performance continues to improve, ECRIN Systems is dedicated to minimize the SWaP constraints of OPALE V2 series. With High-end multi-Core i7 Gen 6 computing performance embedded in 1U rack mount chassis with a small depth of 17.8" (450mm), new μ OPALE V2-SL fits many applications. It will be particularly useful when foot print, performance, reliability and longevity are not optional: military shelter base station, rugged server for harsh environment, simulator, telemetry, telecom, medical imaging, infotainment, control/command station, test bench system, Internet appliance... Distinctively customized oriented thanks to our in-house design center, ECRIN Systems will help to personalize your computer and give you competitive advantage in the industrial world. To precisely meet your requirements, even for small quantities, ECRIN Systems takes full system development responsibility and guarantee long term availability to allow you to concentrate on your added value. From mechanical parts to industrial design, with front and remote user interfaces, user LED's and I/O's, easy customized front and rear connectors, specific face-plate color and design, Lexan polycarbonate sheet with your logo and brand name, we will offer you a unique look that will shape your image and promote your sales. Drop shipping is available to facilitate a rapid, more convenient deployment directly to your end customers.

- > Modified COTS with easy brand naming, configuration and customization for competition advantage
- > Local and remote active management to detect errors before they occur
- > MIL-STD tests passed (for T°C, shock & vibration, humidity, noise)
- > Efficient thermal concept to get higher MTBF
- > Reduced TCO with reporting log file and downtime in harsh environments
- > Long life management: up to 7 years with revision control
- > Advanced Multi-Core "Skylake" boosted computing performance with DDR4 speeds and timings
- > Expandability with 1 full-height and full-length PCle Gen3 16x I/O cards
- > Rear rugged MIL SPEC I/O connectors on demand
- > Single or mini redundant PSU, AC or DC versions
- > Optional front door lockable for security control
- > TPM header for SSI



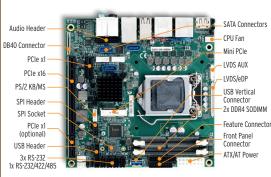
Rack specifications			
Construction	Anti-corrosion and long term heavy-duty steel		
Dimensions (W x H x D)	19" / 1U with 17.8 inch depth (483x44x450mm)		
Weight	<u> </u>		
,	7.5 kg (standard configuration)		
Color	Black		
Cooling	Up to four 40mm ball bearing fans - Fan speed regulation and monitoring		
Power supply	pply 1U form factor, compliant with Mini Redundant PSU		
Drive bays	Two 3"1/2 front accessible drive bay		
Motherboard	Mini-ITX : 170 mm x 170 mm		
	2x slots for full length I/O boards (riser)		
Front panel	Front door for drives bays and USB access		
	Mini-IHM, 4 LEDs with I/O capabilities		
Carton size (W x H x D)	620x600x199 mm		

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			Option w	ith front	door		
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A: 4x tri-co						3"1/2 drive bay	

B: LCD 2x16 characters C: Keyboard (Power & Reset) D: 2x USB 2.0

F: Single or redundant PSU G: motherboard rear I/O H: 2x PCle x8 slots

Electronic enecifications	
Electronic specifications	
Processor	LGA1151 socket for 6 th Gen Intel® Core™ Processor
Chipset	Intel® Q170 Express Chipset
BIOS	AMI EFI in 16MB SPI BIOS with Intel® AMT 11.0 support
Memory	Dual channel DDR4 2133 MHz, up to 32 GB in dual SODIMM sockets
Video	Intel® Gen 9 Graphics supporting 3 independent, simultaneous displays
	3x DisplayPort 1.2 with resolution up to 4096 x 2160 pixels (rear)
Ethernet	2 x GbE (Intel® 1219-LM + Intel® 1211-AT) on rear panel
	Intel® AMT and Wake On LAN support
Disk	3x SATA 6Gb/s ports
	1 Mini PCIe (full size slot) supporting mSATA
Audio	Realtek® ALC886 (7.1 channel audio via 5 jacks and S/PDIF)
USB	Rear: 4x USB 3.0 connector, 4x USB2.0 connector.
	Internal: 2x USB 3.0 pin header, 1x USB3.0 (vertical type A connector) /
	2x USB 2.0 on front
TPM	TPM 1.2, chipset Atmel AT97SC32O4
SEMA® Support	Voltage/current monitoring, power sequence debug support, AT/ATX mode
	control, logistics and forensic information, flat panel control, general
	purpose I2C, failsafe BIOS (dual BIOS), watchdog timer and triple Smart
	Fan control
1/0	PS/2 keyboard/mouse : 1x PS/2 internal headers
	Serial ports : 1x RS-232/422/485/485 + 3x RS-232
	Digital IO : 10 GPIO via onboard feature connector
Expansion Slots	1 PCIe x16 Gen3 - 1 PCIe x1 Gen2
	1 Mini PCIe (full size slot) supporting PCIe + USB or mSATA





Environmental specimentions		
Temperature	Operating: 0~45°C (MIL STD 810 G, method 502.5 / 501.5) - Storage: -20~80°C	
Humidity	Operating : 5%-90% non-condensing	
Altitude	0-2000m (0-6600ft) operating	
Shocks*	Operating: 20G @ 11ms / 15G @ 20ms - 6 axis (MIL STD 810 G, method. 516.6)	
Vibrations*	Operating: 5~7Hz / 10mm, 10~2000Hz / 2G - 3 axis, 2 sweeps, 15min (MIL STD 810 G, method	

od. 514.6) 43.7 dBA (Iddle), 52.5 dBA (50%), 54.6 dBA (80%) - MIL-STD-740-1 EMC: 2014/30/UE; EN 61000-6-2, EN55032, EN 55024 - SAFETY: 2014/35/UE; EN60950-1: 2006 2nd edition A11: 2009 + A1: 2010 + A12: 2011 + A2: 2014 CE certification

System Monitoring and

- > Intel® AMT for remote management
- > Local control with embedded HMI (Windows & Linux services)
 - FAN control & monitoring - System & network information
 - Watchdog & elapsed time counter
 - Redundant P/S default
- Alarm (fan, temperature, redondant P/S),
- Log file - User script launch form menu entry
- Easy configuration with .TXT file

- > Customization:
- Front panel design
- Specific I/O on front panel / rear panel
- Specific H/W configurations
- Specific S/W functionality

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Stand	dard configuration		Options	
Powe	Power Supply Unit ATX 12V - 300W - High Efficiency 80+		Processor	Intel® Core™ i7-6700 Processor, 4C GT2 8M 3.4/4.0 GHz, 65W
		90 ~ 264 VAC full range / 47~63 Hz		Intel® Core™ i7-6700TE Processor, 4C GT2 8M 2.4/3.4 GHz, 35W
		5V@18A, 12V@22A, -12V@0.5A, 3.3V@16A, 5VSB@2A		Intel® Core™ i5-6500 Processor, 4C GT2 6M 3.2/3.6 GHz, 65W
Option for 2x 220W Redundant 1U P/S			Intel® Core™ i5-6500TE Processor, 4C GT2 6M 2.3/3.3 GHz, 35W	
		High Efficiency (80+), 90-264VAC auto range /47-63Hz		Intel® Core™ i3-6100 Processor, 2C GT2 4M, 65W
		5V@16A, 12V@17.5A, -12V@0.3A, 3.3V@16A, 5VSB@2A		Intel® Core™ i3-6100TE Processor, 2C GT2 4M 2.7 GHz, 35W
Drive	S	2 x 2.5" SATA Removable Drive Enclosure	Memory	DDR4-2133 : 4Go / 8Go / 16Go / 32Go
		1 x 3.5" front accessible drive bay free	Disk	- SLC & MLC Solid State Drive (32 Go ~ 2To)
Front	: I/0	2 x USB 2.0		- Up to 4x hot swap 2.5" SSD with optional 2 in1 drive bays
Rear	1/0	3x Display Port, + 2x GbE	OS	- Microsoft® Windows® 7 32/64-bit, Windows 8.1 & 10 64-bit
		4x USB 3.0 + 4x USB 2.0 + Audio 7.1		- Linux 32/64-bit

*With SSD

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